

SGM3732 PWM Dimming, 38V Step-Up LED Driver

GENERAL DESCRIPTION

The SGM3732 is a versatile constant current LED driver with a high efficiency step-up converter architecture. The low-side power MOSFET is integrated in the device, significantly shrinking the overall PCB layout area and minimizing the total number of external components. Unique technology and high 1.35A current limit allow SGM3732 to drive up to 38V output (10 LEDs in series). Alternatively, SGM3732 can deliver 260mA total current with 3 series LEDs per string. It can also maximize the current capability while achieving high conversion efficiency. The optimized 1.1MHz switching frequency results in reduced conduction loss and small external component size. Digital PWM dimming interface is integrated to adjust LED current. The PWM frequency is in the range from 2kHz to 60kHz.

Various protection features are built into the SGM3732, including cycle-by-cycle input current limit protection, open LED (output over-voltage) protection and thermal shutdown protection. The leakage current in shutdown mode is less than 1µA.

The SGM3732 is available in Green TSOT-23-6 package. It operates over an ambient temperature range of -40 $^{\circ}$ C to +85 $^{\circ}$ C.

FEATURES

- Wide Output Range: Up to 10 Series LEDs
- Integrated 40V High Current Switch (1.35A Limit)
- 2.7V to 5.5V Input Voltage Range
- High Efficiency PWM Converter
- Low 200mV Feedback Voltage
- 500kΩ Pull-Down Resistor on CTRL Pin
- 2kHz to 60kHz PWM Dimming Frequency
- 38V Open LED Protection
- 1.1MHz Switching Frequency
- Integrated Soft-Start Function
- Less than 1µA Shutdown Current
- Simple, Small Solution Size
- Available in Green TSOT-23-6 Package
- -40°C to +85°C Operating Temperature Range

APPLICATIONS

LED Backlighting Mobile Phones Handheld Devices Digital Photo Frames Automotive Navigation



SGM3732

PWM Dimming, 38V Step-Up LED Driver

PACKAGE/ORDERING INFORMATION

| MODEL | PACKAGE DESCRIPTION | SPECIFIED TEMPERATURE RANGE | ORDERING NUMBER | PACKAGE MARKING | PACKING OPTION |
|---------|------------------------|-----------------------------------|--------------------|--------------------|---------------------|
| SGM3732 | TSOT-23-6 | -40°C to +85°C | SGM3732YTN6G/TR-V1 | SKAXX | Tape and Reel, 3000 |

NOTE: XX = Date Code.

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

MARKING INFORMATION



Date code - Month ("A" = Jan. "B" = Feb. ··· "L" = Dec.)
 Date code - Year ("A" = 2010, "B" = 2011 ···)
 Chip I.D.

For example: SKAFA (2015, January)

ABSOLUTE MAXIMUM RATINGS

| Input Voltage, V _{IN} | 0.3V to 6V |
|-------------------------------------|--------------------------------|
| High Voltage Nodes, SW, VOUT | 0.3V to 40V |
| Other Pins, FB, CTRL | 0.3V to V _{IN} + 0.3V |
| Package Thermal Resistance | |
| TSOT-23-6, θ _{JA} | 120°C/W |
| Junction Temperature | +150°C |
| Storage Temperature Range | 65°C to +150°C |
| Lead Temperature (Soldering, 10sec) | +260°C |
| ESD Susceptibility | |
| HBM | 4000V |
| MM | 200V |

RECOMMENDED OPERATING CONDITIONS

| Input Voltage Range | 2.7V to 5.5V |
|-----------------------------|---------------|
| Operating Temperature Range | 40°C to +85°C |

OVERSTRESS CAUTION

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

ESD SENSITIVITY CAUTION

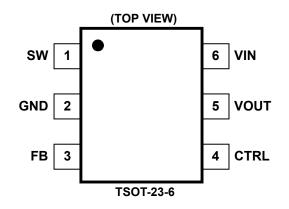
This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.



PIN CONFIGURATION



PIN DESCRIPTION

| PIN | NAME | FUNCTION |
|-----|------|--|
| 1 | SW | Converter Switching Node. |
| 2 | GND | Ground. |
| 3 | FB | Output Feedback Pin Regulated at 200mV. |
| 4 | CTRL | Control Pin of the Boost Regulator. It is a multi-functional pin which can be used for enable control and digital PWM dimming. |
| 5 | VOUT | Output and Over-Voltage Protection Pin. |
| 6 | VIN | IC Supply. Connect VIN to a supply voltage between 2.7V and 5.5V. |

TYPICAL APPLICATION

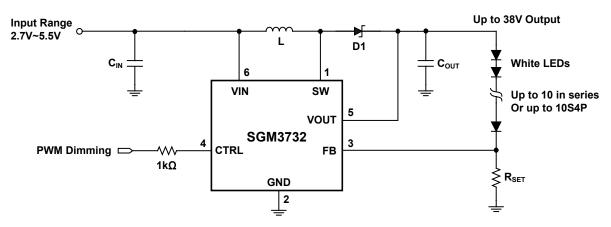


Figure 1. Typical Application Circuit



ELECTRICAL CHARACTERISTICS (1)

 $(V_{IN} = 3.6V, L = 10 \mu H, C_{IN} = 10 \mu F, C_{OUT} = 0.47 \mu F, Full = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ typical values are at } T_A = +25^{\circ}C, \text{ unless otherwise}$ noted.)

| PARAMETER | SYMBOL | CONDITIONS | TEMP | MIN | TYP | MAX | UNITS |
|---|-----------------------|---|-------|------|-------|-------|-------|
| IC SUPPLY | | <u>.</u> | | | | | |
| Input Voltage Range | V _{IN} | | Full | 2.7 | | 5.5 | V |
| Input Under-Voltage Lockout | UVLO | Rising edge | +25°C | | 2.5 | 2.6 | V |
| UVLO Hysteresis | V _{HYS} | | +25°C | | 0.15 | | V |
| Quiescent Current (Non Switching) | | V _{FB} = 0.4V | +25°C | | 0.20 | 0.35 | mA |
| Operating Current (Switching) | lα | V _{FB} = 0V | +25°C | | 0.72 | 1.5 | mA |
| VIN Pin Shutdown Current | I _{SHDN} | V _{EN} = 0V | +25°C | | 0.1 | 1 | μA |
| STEP-UP CONVERTER | L | | | 1 | | 1 | I |
| Voltage Feedback Regulation Voltage | V _{REF} | | Full | 192 | 200 | 212.5 | mV |
| Voltage Feedback Regulation Voltage Under Brightness Control | V _{REF_PWM} | f _{PWM} = 10kHz, duty cycle = 3% | +25°C | 3.5 | 6 | 8.5 | mV |
| V _{REF} Filter 3dB Frequency | f _{REF(3dB)} | | +25°C | | 600 | | Hz |
| Voltage Feedback Input Bias Current | I _{FB} | | Full | | 0.001 | 0.3 | μA |
| SW Pin Leakage Current | I _{SW} | | +25°C | | 0.01 | 1 | μA |
| Peak NMOS Current Limit | I _{LIM} | | +25°C | | 1.35 | | А |
| Oscillator Frequency | fs | | Full | 0.90 | 1.10 | 1.4 | MHz |
| Over-Voltage Threshold | V _{OVP} | Measured at VOUT pin | Full | 35.5 | 38.0 | 40.5 | V |
| Start-Up Time | ts | | +25°C | | 800 | | μs |
| CONTROL | | | | L | | | |
| Logic Low Threshold | VIL | | Full | | | 0.35 | V |
| Logic High Threshold | VIH | | Full | 1.5 | | | V |
| PWM Dimming Frequency Range | DFR | | +25°C | 2 | | 60 | kHz |
| Minimum Shutdown Pulse Width Timing | t _{OFF} | | +25℃ | 3 | | | ms |
| Junction Thermal Shutdown Threshold | | | | | 150 | | °C |
| Junction Thermal Shutdown Hysteresis | | | | | 15 | | °C |

NOTE:

1. The SGM3732 is guaranteed to meet performance specifications over the -40°C to +85°C operating temperature range by design, characterization and correlation with statistical process controls.

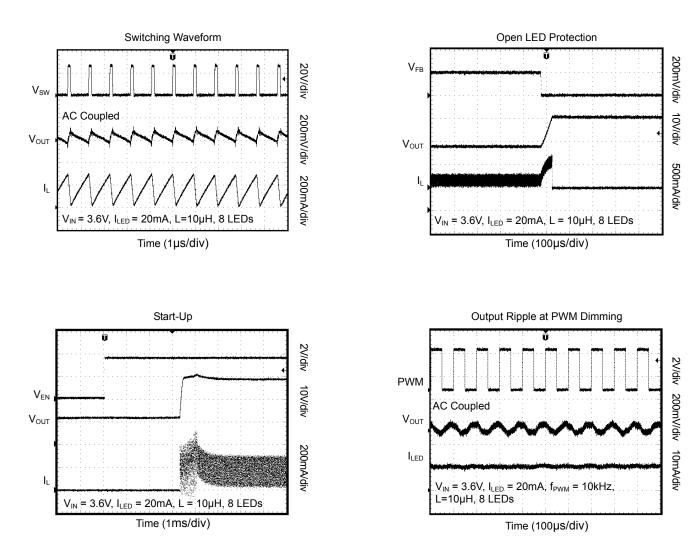


RECOMMENDED COMPONENTS OF TEST CIRCUITS

| | COMPONENT | | COMPONENT |
|----------|-------------------|-----------|------------------------|
| INDUCTOR | 22µH/CD75NP-220KC | | 10µF/C2012X7R1H106KT |
| | 10µH/CD75NP-100KC | CAPACITOR | 0.47µF/C2012X7R1H474KT |
| DIODE | MBR0540 | | |

TYPICAL PERFORMANCE CHARACTERISTICS

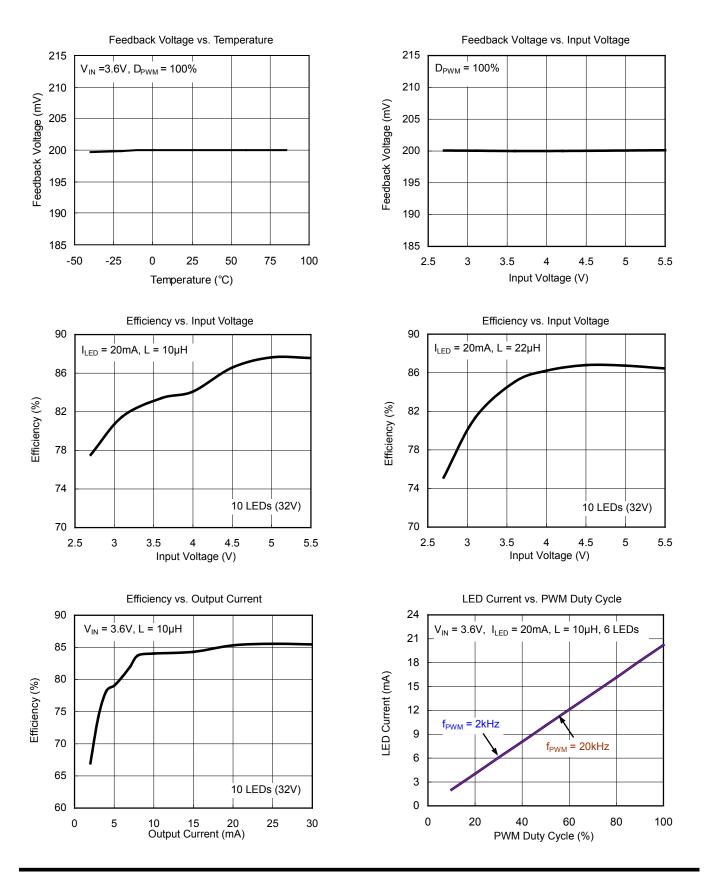
 T_{A} = +25°C, L = 10µH, C_{IN} = 10µF, C_{OUT} = 0.47µF, unless otherwise noted.





TYPICAL PERFORMANCE CHARACTERISTICS

 T_A = +25°C, L = 10µH, C_{IN} = 10µF, C_{OUT} = 0.47µF, unless otherwise noted.





SGM3732

FUNCTIONAL BLOCK DIAGRAM

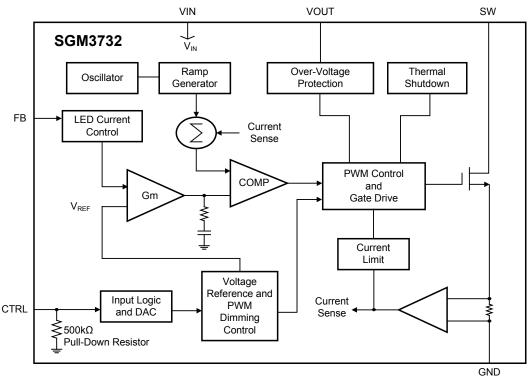


Figure 2. SGM3732 Block Diagram

FUNCTIONAL DESCRIPTION

The SGM3732 uses a constant-frequency currentmode boost converter architecture to control the LED current by regulating the feedback voltage. Please refer to the FUNCTIONAL BLOCK DIAGRAM above for an explanation of SGM3732 operation. The beginning of each cycle turns on the Power MOSFET. A slope compensation ramp is added to the output of the current sense amplifier and the result is fed into the positive input of the comparator (COMP). When this voltage goes above the output voltage of the error amplifier (Gm), the Power MOSFET is turned off. The voltage at the output of the Gm block amplifies the difference between the reference voltage and the feedback voltage (FB), so that FB voltage can be regulated to the reference voltage.

The SGM3732 has built-in soft-start to limit the inrush current during start-up and to limit the amount of overshoot on the output. Protection features in the SGM3732 include over-voltage protection (OVP), cycle-by-cycle current limit protection and thermal shutdown. OVP protects in the event where an LED fails open, which forces the feedback voltage to zero. This causes the boost converter to operate in maximum duty cycle mode, ramping up the output voltage. Switching will stop when the output reaches the OVP threshold. The OVP feature protects the IC from damaging itself by exceeding the voltage rating on SW/VOUT pins.

For the brightness dimming control of the SGM3732, the IC provides typically 200mV feedback voltage when the CTRL pin is pulled constantly high. However, CTRL pin allows a PWM signal to reduce this regulation voltage by changing the PWM duty cycle to achieve LED brightness dimming control. An internal low pass filter (600Hz) is used to filter the pulse signal. The relationship between the duty cycle and FB voltage can be calculated as following equation.

$$V_{FB} = Duty \times 200 mV$$

Where:

Duty = duty cycle of the PWM signal 200mV = internal reference voltage

The PWM frequency is in the range from 2kHz to 60kHz, and the recommended minimum PWM duty cycle is 3% for no blind dimming.



APPLICATION INFORMATION

Inductor Selection

A 6.8µH to 22µH inductor is recommended for 10/8/6 series LED applications and 10S4P LED applications. If high efficiency is a critical requirement, a low DCR inductor should be selected. The inductor's saturation current rating should also exceed the peak input current, especially for high load current application (like 10S4P).

Capacitor Selection

Small size ceramic capacitors are ideal for SGM3732 application. An input capacitor in the range of 1μ F to 22μ F and a 0.47μ F output capacitor are suggested for 10/8/6 series LED applications. For higher output current applications like 10S4P, larger value output capacitors like 2.2 μ F are recommended to minimize output ripple.

Diode Selection

The current rating of the Schottky diode should exceed the peak current of the boost converter. The voltage rating should also exceed the target output voltage.

LED Maximum Current Setting

LED maximum current setting, I_{MAX} , is determined by the feedback resistor (R_{SET} in Figure 3). The feedback voltage is internally set at 200mV when the PWM dimming duty cycle = 100%. The LED current is programmed according to the formula I_{MAX} = 200mV/ R_{SET} . For accurate LED current settings, precision 1% resistors are recommended. The formula and table for R_{SET} selection are shown below.

R_{SET} = 200mV/I_{MAX}

Table 1. Current Setting Resistor

| R _{SET} (Ω) | I _{MAX} Current (mA) |
|----------------------|-------------------------------|
| 200 | 1 |
| 40.2 | 5 |
| 20.0 | 10 |
| 13.3 | 15 |
| 10.0 | 20 |
| 6.65 | 30 |
| 2.00 | 100 |

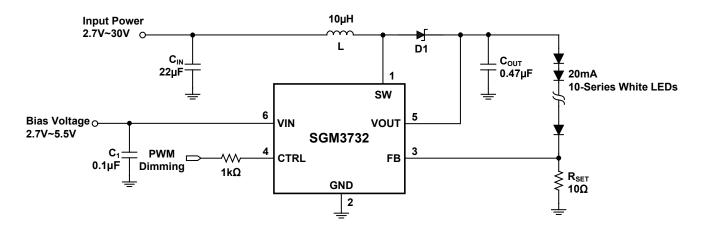


Figure 3. Application Circuit for 10 LEDs in Series with 20mA Current (VIN can be tied to input power rail if less than 5.5V)



APPLICATION INFORMATION

PCB Layout Considerations

As for all switching power supplies, especially those high frequency and high current ones, layout is an important design step. If layout is not carefully done, the regulator could suffer from instability as well as noise problems. To reduce switching losses, the SW pin rise and fall times are made as short as possible. To prevent radiation of high frequency resonance problems, proper layout of the high frequency switching path is essential. Minimize the length and area of all traces connected to the SW pin and always use a ground plane under the switching regulator to minimize inter-plane coupling. The loop including the PWM switch, Schottky diode, and output capacitor, contains high current rising and falling in nanosecond and should be kept as short as possible. Both B1 and B2 (in Figure 4) magnetic Beads are recommended to be used to reduce EMI.

The input and the output bypass capacitors should be placed as close to the IC as possible. Minimize trace lengths between the IC and the inductor, the diode and the output capacitor; keep these traces short, direct, and wide. A recommended PCB layout is shown in Figure 5.

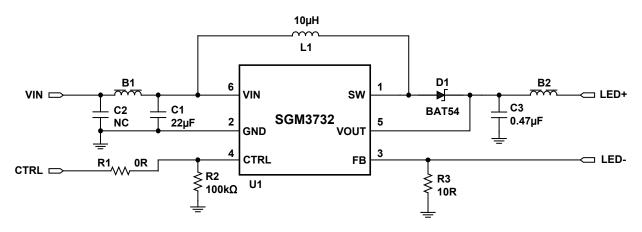


Figure 4. Schematic

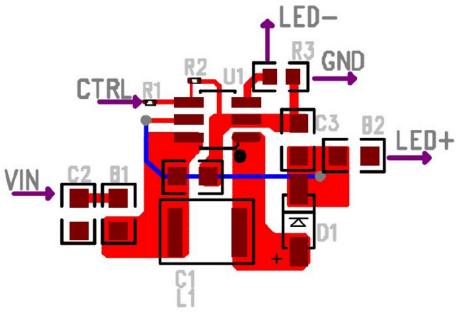
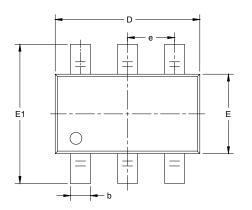


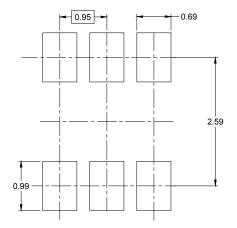
Figure 5. Recommended PCB Layout



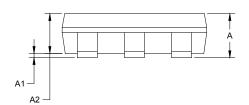
PACKAGE OUTLINE DIMENSIONS

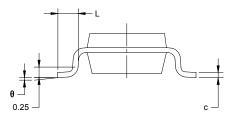
TSOT-23-6





RECOMMENDED LAND PATTERN (Unit: mm)



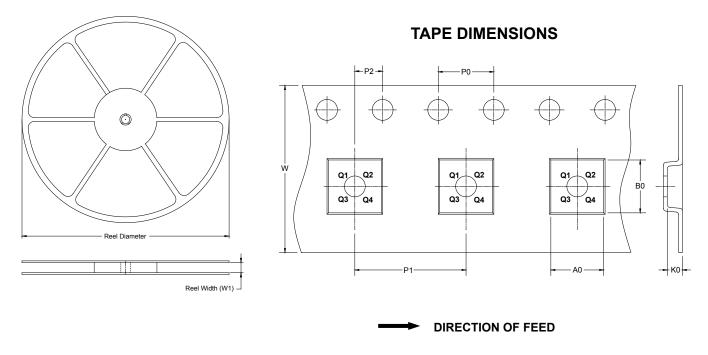


| | Dimer | nsions | Dimensions | | | |
|--------|----------|--------|------------|-------|--|--|
| Symbol | In Milli | meters | In Inches | | | |
| | MIN MAX | | MIN | MAX | | |
| A | | 1.000 | | 0.043 | | |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 | | |
| A2 | 0.700 | 0.900 | 0.028 | 0.039 | | |
| b | 0.300 | 0.500 | 0.012 | 0.020 | | |
| с | 0.080 | 0.200 | 0.003 | 0.008 | | |
| D | 2.850 | 2.950 | 0.112 | 0.116 | | |
| E | 1.550 | 1.650 | 0.061 | 0.065 | | |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 | | |
| е | 0.950 | BSC | 0.037 | ' BSC | | |
| L | 0.300 | 0.600 | 0.012 | 0.024 | | |
| θ | 0° 8° | | 0° | 8° | | |



TAPE AND REEL INFORMATION

REEL DIMENSIONS



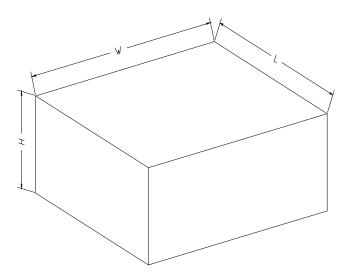
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

| Package Type | Reel Diameter | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | P1 (mm) | P2 (mm) | W (mm) | Pin1 Quadrant | |
|--------------|------------------|--------------------------|------------|------------|------------|------------|------------|------------|-----------|------------------|--------|
| TSOT-23-6 | 7″ | 9.5 | 3.2 | 3.1 | 1.1 | 4.0 | 4.0 | 2.0 | 8.0 | Q3 | DD0001 |



CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

| Reel Type | Length (mm) | Width (mm) | Height (mm) | Pizza/Carton | |
|-------------|----------------|---------------|----------------|--------------|--------|
| 7" (Option) | 368 | 227 | 224 | 8 | |
| 7" | 442 | 410 | 224 | 18 | DD0002 |



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